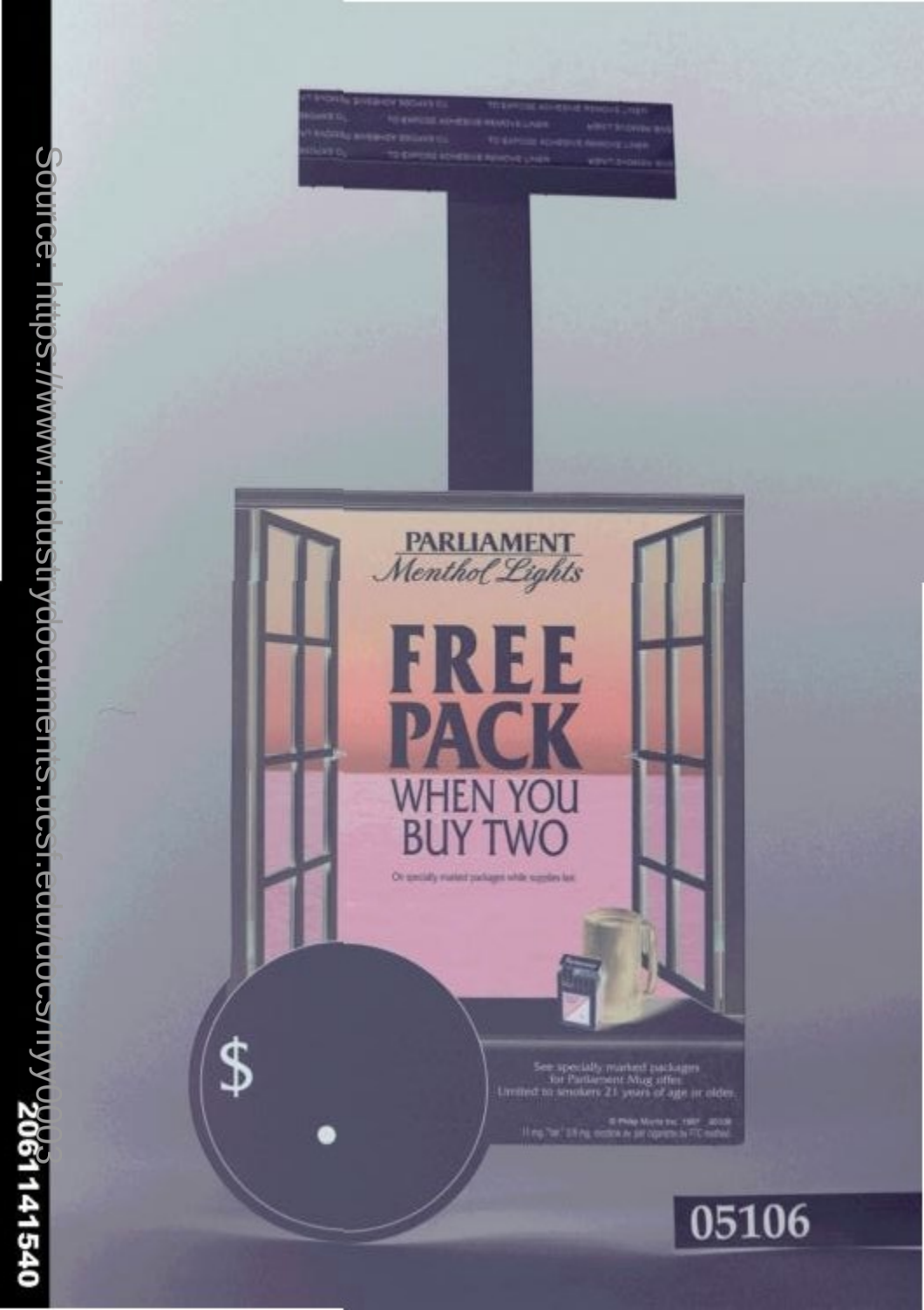

Source: https://www.industrydocuments.ucsf.edu/docs/nyqd0141540
2061141540